

GLF71307 Nano-Current Consumed, I₀Smart[™] LoadSwitch with Slew Rate Control

Product Brief

DESCRIPTION

The GLF71307 is an ultra-efficiency, 2.0 A rated, integrated load switch with integrated slew rate control. The best in class efficiency makes it an ideal choice for use in IoT, mobile, and wearable electronics.

The GLF71307 features an ultra-efficient I_QSmart^{TM} technology that supports the lowest quiescent current (I_Q) and shutdown current (I_{SD}) inx the industry. Low I_Q and I_{SD} solutions help designers to reduce parasitic leakage current, improve system efficiency, and increase battery lifetime.

The GLF71307 integrated slew rate control greatly enhances system reliability by mitigating bus voltage swings during switching events. Where uncontrolled switches can generate high inrush currents that result in voltage droop and/or bus reset events, the GLF slew rate control specifically limits inrush currents during turn-on to minimize voltage droop.

The GLF71307 can be used in multiple voltage rail applications which helps to simplify inventory management and reduces operating cost.

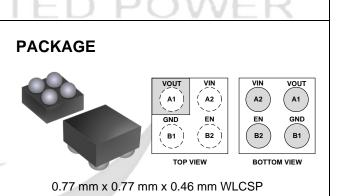
The GLF71307 Load Switch device is small utilizing a wafer level chip scale package with 4 bumps in a 0.77 mm x 0.77 mm x 0.46 mm die size and a 0.4 mm bump pitch.

FEATURES

- Ultra-Low I_Q : 1 nA Typ @ 5.5 V_{IN}
- Ultra-Low Isd: 19 nA Typ @ 5.5 VIN
- Low $R_{ON} = 34 \text{ m}\Omega \text{ Typ} @ 5.5 V_{IN}$
- IOUT Max = 2.0 A
- Wide Input Range: 1.1 V to 5.5 V 6 V abs max
- Controlled Rise Time: 9 us at 3.3 VIN
- Internal EN Pull-Down Resistor
- Integrated Output Discharge Switch
- Temperature Range: 40 to 85 °C
- HBM: 6 kV, CDM: 2 kV
- Ultra-Small: 0.77 mm x 0.77 mm

APPLICATIONS

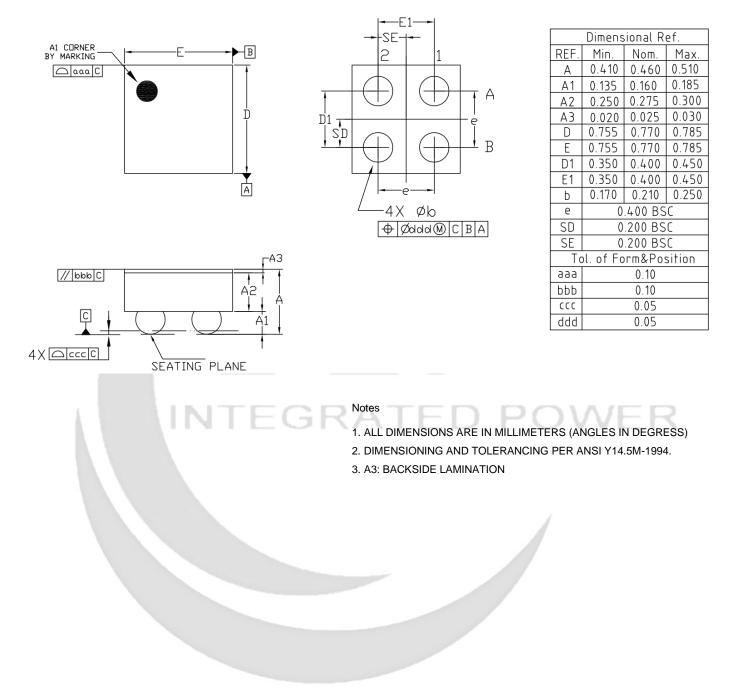
- Wearables
- Data Storage, SSD
- Mobile Devices
- Low Power Subsystems





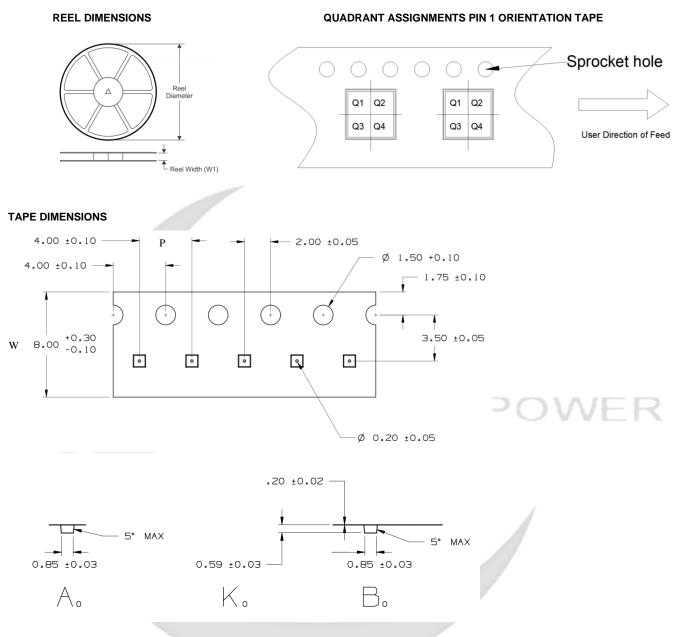
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PACKAGE OUTLINE



TAPE AND REEL INFORMATION

INTEGRATED POWER



Device	Package	Pins	SPQ	Reel Diameter(mm)	Reel Width W1	A0	В0	KO	Ρ	w	Pin1
GLF71307	WLCSP	4	4000	180	9	0.85	0.85	0.59	4	8	Q1

Remark:

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- C0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P: Pitch between successive cavity centers

单击下面可查看定价,库存,交付和生命周期等信息

>>GLF(杰夫微)